

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Stefan JOHANSSON et al.

Serial No. (unknown)

Filed herewith

FLEXIBLE MICROSYSTEM AND  
BUILDING TECHNIQUES

31A  
10/31/01  
M. Pruden

PRELIMINARY AMENDMENT

Commissioner for Patents

Washington, D.C. 20231

Sir:

Prior to calculation of the filing fee, please  
amend the above-identified application as follows:

IN THE CLAIMS:

Amend claim 3 as follows:

*Al*

~~3. (Amended) The transducer microsystem  
according to claim 1, characterised in that said flexible  
printed circuit board (10) has an elastic deformation,  
whereby said flexible printed circuit board (10) forms a  
general support for internal (30,32) and external forces.~~

Amend claim 4 as follows:

~~--4. (Amended) The transducer microsystem  
according to claim 1, characterised in that said flexible  
printed circuit board (10) is elastically deformed to apply~~